



Cohu Announces New Tri-Temperature Active Thermal Technology for Emerging Processors

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POWAY, Calif.--(BUSINESS WIRE)--Dec. 27, 2016-- Cohu, Inc. (NASDAQ: COHU) today announced the introduction of its next generation tri-temperature, active thermal control technology on the Eclipse platform.

Eclipse delivers scalable performance for testing a wide range of semiconductors, from analog ICs to high performance mobile processors. The new capability incorporates Cohu's proprietary tri-temperature T-Core thermal technology providing precise, multi-site temperature management and yield optimization for an emerging class of automotive processors. It also enables both IDM and fabless customers to test high-end processors used in augmented virtual reality and deep-learning applications, giving continuity to Cohu's leadership in advanced thermal test.

"The new Eclipse tri-temperature offering will further solidify Cohu's test handling leadership in the growing automotive market. We are well positioned to address the emerging ADAS (Automated Driver Assist Systems) test requirements where a new category of powerful processors need precise temperature control in stringent environmental conditions. Recent multiple customer wins highlight Cohu's thermal architectural advantage in the Eclipse pick-and-place handler," said Samer Kabbani, General Manager of Cohu's Delta Design business unit.

About Cohu:

Cohu is a leading supplier of semiconductor test and inspection handlers, micro-electro mechanical system (MEMS) test modules, test contactors and thermal sub-systems used by global semiconductor manufacturers and test subcontractors as well as a supplier of mobile microwave communications equipment.

Forward Looking Statements:

Certain matters discussed in this release, including statements concerning Cohu's Eclipse product and T-Core thermal technology are forward-looking statements that are subject to risks and uncertainties that could cause actual results to differ materially from those projected or forecasted. Such risks and uncertainties include, but are not limited to, our ability to convert new products under development into production on a timely basis, support product development and meet customer delivery and acceptance requirements for next generation equipment, failure to obtain customer acceptance resulting in the inability to recognize revenue and accounts receivable collection problems, our reliance on patents and intellectual property, compliance with U.S. export regulations, and the cyclical and unpredictable nature of capital expenditures by semiconductor manufacturers. These and other risks and uncertainties are discussed more fully in Cohu's filings with the Securities and Exchange Commission, including the most recently filed Form 10-K and Form 10-Q. Cohu assumes no obligation to update the information in this release.



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